

**Upcoming: April 2-7, 2nd World Congress on Microwave Processing, Endorsed; April 24-28, MRS Spring Meeting, MRS.**

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313.

**MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.**

▼ identifies a new or revised entry this month.

See the November 1999 MRS BULLETIN for January 2000 Calendar entries.

## FEBRUARY 2000

**3-5 Xlth Annual General Meeting of MRS-I, Baroda, India.** Prof. L.M. Manocha, Head, Department of Materials Science, Sardar Patel University, Vallabh Vidyanagar-388 120, Gujarat, India; tel. 02692-35183; fax 02692-36475/35183; or e-mail LMM@PCBBS.NET. **MRS-I.**

**7-9 2000 IEEE Intl. Solid-State Circuits Conf., San Francisco, CA.** D. Suiters; 202-331-2000; e-mail isscc@courtesyassoc.com.

**7-11 AVS Intl. Conf. on Microelectronics and Interfaces, Santa Clara, CA.** American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@vacuum.org; http://www.vacuum.org.

**11-14 OSA Vision Science and Its Applications Topical Meeting, collocated with OSA Laser Applications to Chemical and Environmental Analysis Topical Meeting, Santa Fe, NM.** Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**13-16 ▼ Advanced Solid-State Lasers Conf., Davos, Switzerland.** Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1907 fax 202-416-6140; e-mail cust.serv@osa.org; http://www.osa.org/mtg-conf.

**14-17 Microscopy and Microanalysis of Engineering Materials (MMEM2000), Melbourne, Victoria, Australia.** Astrid Nordmann, MMEM Conference Secretariat, Centre for Advanced Materials Technology, Monash University, Wellington Road, Clayton, Victoria, 3168, Australia; 61-3-9905-5791; fax 61-3-9904-4998; e-mail mmem@eng.monash.edu.au; http://www.monash.edu.au/eng/microengineering/mmem/.

**14-17 OSA Advanced Solid-State Lasers Topical Meeting, Davos, Switzerland.** Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**15-17 SEMICON/Korea, Seoul, Korea.** SEMI North America, 805 E. Middlefield Rd., Mountain View, CA 94043-4080; 650-964-5111; fax 650-967-5375; e-mail semihq@semi.org; http://www.semi.org.

**20-23 23rd Annual Meeting of the Adhesion Society, Myrtle Beach, SC.** K. Mills, 2 Davidson Hall, Virginia Tech., Blacksburg, VA 24061; 540-231-7257.

**20-24 TMS Annual Meeting, Nashville, TN.** Customer Service Dept., TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; http://www.tms.org.

**20-25 6th Int. Conf. on Materials and Mechanisms of Superconductivity and High Temperature Superconductors, Houston, TX.** M<sup>2</sup>S-HTSC-VI Secretariat, Texas Center for Superconductivity, Univ. of Houston, Houston, TX 77204-5932; fax 713-743-8126; e-mail sbutler@uh.edu; http://m2s-conf.uh.edu.

**21-24 ▼ Intl. Conf. on Emerging Microelectronics and Interconnection Technologies, Bangalore, India.** Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; www.imaps.org.

**27-3 SPIE 25th Annual Intl. Symposium on Microlithography, Santa Clara, CA.** SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; http://www.spie.org.

**28-1 ▼ Conf. on Iron and Steel Scrap and Scrap Substitutes, Atlanta, GA.** C. Jones, Gorham Conferences, Inc., P.O. Box 250, Gorham, ME 04038-0250; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com.

**28-1 Materials for Advanced Metallizations, Stresa, Italy.** L. Miglio, Dipartimento di Scienza dei Materiali, Univ. di Milano, "Bicocca" via Cozzi 53, 20125 Milano, Italy, 39-2-6448-5217; fax 39-347-254-8580; e-mail leo.miglio@mater.unimi.it; http://www.infim.it/mam2000.

**28-2 Natl. Space and Missile Materials Symposium—Materials, Processes, and Applications: Challenges of Space, San Diego, CA.** Natl. Space and Missile Materials Symposium, c/o Anteon Corp., 5100 Springfield St., Ste. 509, Dayton, OH 45431-1264; 937-254-7950; http://www.usasymposium.com.

## MARCH 2000

**1-3 AAPS Workshop on Bioanalytical Methods Validation for Macro Molecules, Arlington, VA.** American Association of Pharmaceutical Scientists, 1650 King St., Ste. 200, Alexandria, VA 22314-2747; 703-548-3000; fax 703-684-7349; e-mail pr@aaps.org; http://www.aaps.org.

**1-3 Chemical Process Development Workshop, Frazer, PA.** Caudron Process Chemistry, 383 Phoenixville Pike, Malvern, PA 19355; 610-727-2215; fax 610-727-5762.

**5-9 ▼ AIChE Spring National Meeting, Atlanta, GA.** American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences.

**5-9 ▼ Conf. on Smart Structures and Materials and Nondestructive Evaluation Techniques for Aging Infrastructure and Manufacturing, Newport Beach, CA.** SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**5-10 Optical Fiber Communication Conf., Baltimore, MD.** Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**6-8 ▼ Intl. Symposium on Advanced Packaging Materials, Braselton, GA.** Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; www.imaps.org.

**6-8 Polymer Stabilizers and Modifiers Conf., Hilton Head Island, SC.** Inst. of Materials Science, 75 S. Manheim Blvd., New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail nainquiry@ims-np.org/narcStab.

**7-10 ▼ Foundrex India and Metallurgy India 2000 Conf., New Delhi, India.** Messe Düsseldorf North America, 150 N. Michigan Ave., Ste. 2920, Chicago, IL 60601; 312-718-5180; fax 312-781-5188; www.mdna.com.

**7-12 Optical Fiber Communication Conf., Baltimore, MD.** Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**12-16 129th TMS Annual Meeting, Nashville, TN.** TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail wilson@tms.org; http://www.tms.org.

**13-16 Semiconductor Pure Water and Chemicals Conf., Santa Clara, CA.** D. Belanger-Palmer, Conf. Coordinator, SPWCC, c/o Balazs Analytical Lab., 252 Humboldt Ct., Sunnyvale, CA 94089; 408-745-0600; fax 408-734-2276; e-mail spwcc@balazs.com.

**13-17 ▼ 18th General Conf. of the Condensed Matter Division of the European Physical Society, jointly with the Japanese Physical Society and Swiss Physical Society, Montreux, Switzerland.** Conf. Secretariat CMD18-2000; Lab. für Festkörperphysik, ETH Hönggerberg, CH-8093 Zurich, Switzerland; 41-1-633-2315; fax 41-1-633-1077; e-mail eps-cmd18@psi.ch; www.eps-cmd18.ch.

**14-15 ▼ 8th Annual Automotive Laser Applications Workshop, Dearborn, MI.** Univ. of Michigan, Ctr. for Professional Development, 273 Chrysler Ctr., 2121 Bonisteel Blvd., Ann Arbor, MI 48109-2092; 734-647-7200; fax 734-647-7182; http://cpd.engin.umich.edu.

**15-16 SEMICON/China, Beijing, China.** SEMI North America, 805 E. Middlefield Rd., Mountain View, CA 94043-4080; 650-964-5111; fax 650-967-5375; e-mail semihq@semi.org; http://www.semi.org.

**19-23 ▼ 12th APS Topical Conf. on Atomic Processes in Plasmas, Reno, NV.** R.C. Mancini, Dept. of Physics, Univ. of Nevada, Reno, NV 89557; 775-784-6595; fax 775-784-1398; e-mail apip@physics.unr.edu; www.physics.unr.edu.

**20-24 APS March Meeting, Minneapolis, MN.** Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; http://www.aps.org.

**26-30 AIChE Spring National Meeting, Atlanta, GA.** AIChE, 3 Park Ave., New York, NY 10016; http://www.aiche.org.

**26-31 ▼ Conf. on Corrosion, Orlando, FL.** NACE Membership Services, P.O. Box 218340, Houston, TX 77218; 281-228-6223; fax 281-228-6329; e-mail msd@mail.nace.org; www.nace.org.

**27-29 3rd Intl. Conf. on Modeling and Simulation of Microsystems, San Diego, CA.** MSM 2000, 4847 Hopyard Rd., Ste. 4-381, Pleasanton, CA 94588; 925-847-9152; fax 925-847-9153; e-mail wenning@dnai.com; http://www.cr.org/MSM2000.

## APRIL 2000

**2-7 2nd World Congress on Microwave Processing, Orlando, FL.** D.E. Clark, Organizing Committee Chair, Dept. of Materials Science and Engineering, 136 MAE, Univ. of Florida, P.O. Box 116400, Gainesville, FL 32611-6400; 352-392-3660; fax 352-846-2033. **Endorsed.**

**3-4 Microscopy of Composite Materials V, Oxford, UK.** Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-1865-248768; fax 44-1865-791237; e-mail meetings@rms.org.uk; http://www.rms.org.uk.

**3-6 3rd Intl. Conf. on Electromagnetic Processing of Materials, Nagoya, Japan.** JATIS, Sogo-Kojimachi, No. 3 Bldg., 1-6 Kojimachi, Chiyoda-Ku, Tokyo 102-0083, Japan; 81-3-3239-4804; fax 81-3-3239-4714; e-mail jatisc@msn.com.

**9-14** Nanostructured Sensors and Other Gas-Reactive Applications, *Barga, Tuscany, Italy*. United Engineering Foundation Conferences, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail [engfnd@aol.com](mailto:engfnd@aol.com); <http://www.engfnd.org>.

**10-11** SPIE Regional Meeting on Optoelectronics, Photonics, and Imaging, *Albuquerque, NM*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org).

**11-13** Intl. Microscopy Conf., *London, UK*. Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-1865-248768; fax 44-1865-791237; e-mail [meetings@rms.org.uk](mailto:meetings@rms.org.uk); <http://www.rms.org.uk>.

**12-14** Materials Congress 2000 and Materials Industries Exhibition, *Wiltshire, UK*. H. Kaune, IOM, 1 Carlton House Terrace, London SW1Y 5DB, UK; 44-20-7451-7360; fax 44-20-7451-7349; e-mail [hilda-kaune@materials.org.uk](mailto:hilda-kaune@materials.org.uk); [www.materials.org.uk](http://www.materials.org.uk).

**15-20** 43rd SVC Annual Conf. *Denver, CO*. Society of Vacuum Coaters, 71 Pinon Hill Place, N.E., Albuquerque, NM 87122-1914; 505-856-7188; fax 505-856-6716; e-mail [svcinfo@svc.org](mailto:svcinfo@svc.org); <http://www.svc.org>.

**16-19** 6th Intl. Multi-disciplinary Conf.: Complexity and Fractals in the Sciences, *Singapore*. <http://www.kingston.ac.uk/fractal>.

**23-28** Conf. on High Power Laser Ablation, *Santa Fe, NM*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org).

**24-28** MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; <http://www.mrs.org/>. **MRS.**

**25-29** 22nd Annual Intl. High Technology, Safety, Industrial Hygiene, and Environmental Conf., *Arlington, VA*. Semiconductor Safety Association, 1313 Dolley Madison Blvd., Ste. 402, McLean, VA 22101; 703-790-1745; fax 703-790-2672; e-mail [ssa@burkinc.com](mailto:ssa@burkinc.com); <http://www.semiconductorsafety.org>.

**26-28** Intl. Conf. on High Density and Systems Packaging, *Denver, CO*. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 888-464-6277; fax 703-758-1066; e-mail [imaps@imaps.org](mailto:imaps@imaps.org); [www.imaps.org](http://www.imaps.org).

**26-30** 2nd Intl. Conf. on Atomic and Molecular Data and Their Applications, *Oxford, UK*. K. Berrington; e-mail [k.berrington@shu.ac.uk](mailto:k.berrington@shu.ac.uk); <http://physics.nist.gov/icamdata>.

**29-2** APS April Meeting, *Long Beach, CA*. APS Headquarters, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail [meetings@aps.org](mailto:meetings@aps.org); <http://www.aps.org>.

**30-3** ACerS 102nd Annual Meeting, *St. Louis, MO*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail [customersvc@acers.org](mailto:customersvc@acers.org); [www.acers.org](http://www.acers.org).

## MAY 2000

**1-3** 6th Intl. Conf. on Remote Sensing for Marine and Coastal Environments, *Charleston, SC*. ERIM/Marine Conf., P.O. Box 134008, Ann Arbor, MI 48113-4008; 734-994-1200; fax 734-994-5123; <http://www.erim-int.com/conf/conf.html>.

**5-6** APS Ohio Section Spring Meeting, *Cincinnati, OH*. M. Ma, Univ. of Cincinnati; e-mail [michael.ma@uc.edu](mailto:michael.ma@uc.edu); [www.aps.org](http://www.aps.org).

**7-12** Conf. on Lasers and Electro-Optics, and Quantum Electronics and Laser Science Conf., *San Francisco, CA*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail [confserv@osa.org](mailto:confserv@osa.org); <http://www.osa.org/mtg-conf>.

**14-16** Conf. on Fluoropolymers, *Maui, HI*. SPI Fluoropolymer Div., 1801 K St. N.W., Ste. 600K, Washington, DC 20006; 202-974-5234.

**14-17** Conf. on Optical Data Storage, *Vancouver, BC, Canada*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org).

**14-18** 12th Intl. Conf. on Indium Phosphide and Related Materials, *Williamsburg, VA*. IPRM'00, IEEE/LEOS, 445 Hoes Lane, P.O. Box 1331, Piscataway, NJ 08855-1331; 732-562-3898; fax 732-562-8434; <http://www.ieee.org/leos>.

**14-19** 197th Meeting of The Electrochemical Society, *Toronto, Ontario, Canada*. The Electrochemical Society, 10 S. Main St., Pennington, NJ 08534-2896; 609-737-1902; fax 609-737-2743; e-mail [ecs@electrochem.org](mailto:ecs@electrochem.org); <http://www.electrochem.org/meetings/>.

**15-20** 6th World Biomaterials Congress, *Kamuela (Big Island), HI*. Society for Biomaterials, 13355 10th Ave. N., Ste. 108, Minneapolis, MN 55441; 612-927-8108; fax 612-927-8127; e-mail [biomaterials.org](mailto:biomaterials.org); <http://www.biomaterials.org>.

**16-19** ACS 32nd Central Regional Meeting, *Covington, KY*. J. Hershberger, Cincinnati Section, American Chemical Society, 102 W. Central Ave., Oxford, OH 45056; <http://www.cmacs2000.org>.

**17-19** Corrosion in Natural and Industrial Environments: Problems and Solutions, *Venice, Italy*. AIM, Piazzale R. Morandi 2, 20121 Milan, Italy; 39-2-7602-1132; fax 39-2-7602-0551.

**21-25** 45th SAMPE Intl. Symposium, *Long Beach, CA*. SAMPE, 1161 Parkview Dr., Covina, CA 91724; 626-331-0616; fax 626-332-8929; e-mail [sampeibo@aol.com](mailto:sampeibo@aol.com); [www.sampe.org](http://www.sampe.org).

**21-26** Conf. on Processing of Fibers and Composites (Polymeric, Metallic, and Ceramic), *Castelveccio, Barga, Italy*. United Engineering Foundation, Engineering Foundation Conferences, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail [engfnd@aol.com](mailto:engfnd@aol.com); <http://www.engfnd.org>.

**22-24** 6th Intl. Conf. on Computer Aided Assessment and Control: Damage and Fracture Mechanics, *Montreal, Canada*. S. Walsh, Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-1703-293-223; fax 44-1703-292-853; e-mail [slwalsh@wessex.ac.uk](mailto:slwalsh@wessex.ac.uk); <http://www.wessex.ac.uk>.

**22-24** Conf. on Soft Magnetic Materials, *Dearborn, MI*. D. Crommett, Intertech Conferences, 19 Northbrook Dr., Portland, ME 04105; 207-781-9800; fax 207-781-2150; e-mail [deborahc@intertechusa.com](mailto:deborahc@intertechusa.com).

**22-26** 5th Intl. Symposium on High-Temperature Corrosion and Protection of Materials, *Ile des Embiez, France*. <http://www.univ-mrs.fr/~cdcl/5th-ishtc.html>.

**22-27** 26th Congress on Chemical Engineering, Environmental Protection, and Biotechnology, *Frankfurt am Main, Germany*. DECHEMA Deutsche Gesellschaft für Chemisches Apparatewesen, Chemische Technik und Biotechnologie e.V., Th. Scheuring, Germany; 49-69-7564-230; fax 49-69-7564-298; <http://www.dechema.de>.

**22-28** 7th Conf. on Intersections Between Particle and Nuclear Physics, *Quebec City, Canada*. A.B. Macinnis; 617-253-9285; e-mail [macinnis@mit.edu](mailto:macinnis@mit.edu); <http://CIPANP.mid.edu>.

**24-26** 3rd Intl. Conf. on Advances in Fluid Mechanics, *Montreal, Canada*. Conf. Secretariat HPC 2000, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail [wit@wessex.ac.uk](mailto:wit@wessex.ac.uk); <http://www.wessex.ac.uk/conferences/2000>.

**28-2** 10th Intl. Offshore and Polar Engineering Conf., *Seattle, WA*. Intl. Society of Offshore and Polar Engineers, P.O. Box 1107, Golden, CO 80402-1107; 303-420-8114; fax 303-420-3760.

**28-2** Intl. Conf. on Transport Processes in Inorganic Materials: Fundamentals to Devices, *Venice, Italy*. CIMTEC, P.O. Box 174, 48018 Faenza, Italy; 39-546-22461; fax 39-546-664138.

**29-2** Centrifugal Materials Processing IV—4th Intl. Workshop on Materials Processing at High Gravity, *Potsdam, NY*. L.L. Regel; Clarkson Univ., Potsdam, NY 13699-5814; 315-268-7672; fax 315-268-3833; e-mail [regel@clarkson.edu](mailto:regel@clarkson.edu); [http://www.clarkson.edu/\\_regel/workshop.htm](http://www.clarkson.edu/_regel/workshop.htm).

**30-2** Intl. Conf. on Electronic Materials and E-MRS Spring Meeting, *Strasbourg, France*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; <http://www-emrs.c-strasbourg.fr>. E-MRS, IUMRS.

**30-3** Intl. Conf. on Powder Metallurgy and Particulate Materials, *New York, NY*. T. Stillman, Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail [stillman@mpif.org](mailto:stillman@mpif.org); [www.mpi.org](http://www.mpi.org).

## JUNE 2000

**5-7** Extreme High Vacuum and Surface Conditioning, *Newport News, VA*. H.F. Dylla, Jefferson Lab., 1200 Jefferson Ave., Newport News, VA 23606; 757-269-7450; fax 757-269-6357; e-mail [dylla@jlab.org](mailto:dylla@jlab.org).

**12-16** 6th Intl. Conf. on Molten Slags, Fluxes, and Salts, *Stockholm, Sweden*. Congrex Sweden AB, P.O. Box 5619, SE-114 86, Stockholm, Sweden; 46-8-459-6600; fax 46-8-661-9125; e-mail [slags2000@congrex.se](mailto:slags2000@congrex.se); <http://www.slags2000.kth.se>.

**12-16** Intl. Conf. on Applications of Photonic Technology, *Quebec City, Canada*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org).

**14-17** 31st Annual Meeting of the APS Division of Atomic, Molecular, and Optical Physics, *Storrs, CT*. D. Dole, Ctr. for Professional Development, Univ. of Connecticut, U-56D, One Bishop Circle, Storrs, CT 06269-4056; 860-486-1072; fax 860-486-5221; e-mail [ddole@access.ced.uconn.edu](mailto:ddole@access.ced.uconn.edu).

**18-22** 13th Topical Conf. on High-Temperature Plasma Diagnostics, *Tucson, AZ*. C.W. Barnes, P-24 MS-E526, Los Alamos National Lab., Los Alamos, NM 87545; 505-665-5687; fax 505-665-3552; e-mail [cbarnes@lanl.gov](mailto:cbarnes@lanl.gov); <http://www.lanl.gov/HTPD2000/>.

**18-23** OSA Diffractive Optics and Micro-Optics Topical Meeting, collocated with OSA Optical Fabrication and Testing Topical Meeting, *Quebec City, Canada*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail [confserv@osa.org](mailto:confserv@osa.org); <http://www.osa.org/mtg-conf>.

**19-21** Intl. Conf. on Computational Methods for Smart Structures and Materials, *Madrid, Spain*. S. Hanley, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail [shanley@wessex.ac.uk](mailto:shanley@wessex.ac.uk); <http://www.wessex.ac.uk/conferences/2000/>.

**19-23** 23rd Meeting of the Electrochemistry Group of the Spanish Royal Society of Chemistry, *San Sebastián, Spain*. T. Fernández Otero, Lab. of Electrochemistry, Univ. of the Basque Country, P.O. Box 1072, 20080 San Sebastián, Spain; 34-943-018186; fax 34-943-212236; e-mail [appfeott@sq.ehu.es](mailto:appfeott@sq.ehu.es).

**21-23** 4th Intl. Meeting on Vector and Parallel Processing, *Porto, Portugal*. Viagens Abreu SA; e-mail [congress.porto@abreu.pt](mailto:congress.porto@abreu.pt); [www.fe.up.pt/vecpar2000/](http://www.fe.up.pt/vecpar2000/).

**21-23** Electronic Materials Conf., *Denver, CO*. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail [tmsgeneral@tms.org](mailto:tmsgeneral@tms.org); <http://www.tms.org/cms>.

**21-23** Intl. Conf. on Mobile and Rapidly Assembled Structures, *Madrid, Spain*. S. Hanley, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail shanley@wessex.ac.uk; <http://www.wessex.ac.uk/conferences/2000/>.

**26-28** 6th Intl. Conf. on Advanced Computational Methods in Heat Transfer, *Madrid, Spain*. Conf. Secretariat Heat Transfer 2000, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail wit@wessex.ac.uk; <http://www.wessex.ac.uk/conferences/2000/>.

**26-2** Seminar on Defect Structures Evolution in Condensed Matter, *Barnaul, Russia*. EDS 2000, General Physics Dept., Altai State Technical Univ., 46 Lenin St., Barnaul, Russia 656099; 007-3852-368-0522; fax 007-3852-260-516; e-mail asba@ab.ru (mailto:asba@ab.ru); <http://www.dcn-asu.ru/structure/cdo/index.ru.html>.

**28-30** Merton C. Flemings Symposium, *Cambridge, MA*. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; <http://www.tms.org/cms>. **Endorsed.**

## JULY 2000

**3-7** 11th Intl. Conf. on Semiconducting and Insulating Materials, *Canberra, Australia*. C. Jagadish, Australian Natl. Univ., Research School of Physical Sciences and Engineering, Canberra, ACT 0200, Australia; 61-2-6249-0363; fax 61-2-6249-0511; e-mail simc2000@anu.edu.au; <http://rpsphysse.anu.edu.au/admin/simc2000/>.

**9-14** 12th European Congress on Electron Microscopy, *Brno, Czech Republic*. <http://www.eurem2000.isibrno.cz>.

**10-12** 6th Intl. Conf. on Residual Stresses, *Oxford, UK*. P. Farrelly, IoM Conferences and Events; 44-171-451-7391; fax 44-171-839-2289; e-mail pauline\_farrelly@materials.org.uk.

**10-12** OSA Optical Amplifiers and Their Applications Topical Meeting, *Quebec City, Canada*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; <http://www.osa.org/mtg-conf>.

**10-13** The Plutonium Futures—The Science Conf., *Santa Fe, NM*. A. Liesse, Plutonium Futures—The Science, Los Alamos Natl. Lab., Nuclear Materials Technology Div., P.O. Box 1663; M.S. E500, Los Alamos, NM 87545; 505-665-5981; fax 505-667-7966; e-mail puconf2000@lanl.gov; <http://www.lanl.gov/pu2000.html>.

**13-15** OSA Integrated Photonics Research Topical Meeting, *Quebec City, Canada*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; <http://www.osa.org/mtg-conf>.

**16-20** 5th Intl. Conf. on Structural and Functional Intermetallics, *Vancouver, British Columbia, TMS*, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; <http://www.tms.org>.

**16-21** Ion Exchange at the Millennium, *Cambridge, UK*. SCI Conf. Secretariat, 14/15 Belgrave Square, London SW1X 8PS, UK; 44-171-235-3681; fax 44-171-235-7743.

**17-21** 5th Intl. Conf. on Diffusion in Materials, *Paris, France*. DIMAT 2000, DECM/SRMP, Bat. 520, CEA/SACLAY, 91191 Gif-sur-Yvette Cedex, France; e-mail dimat2000@cea.fr; [www.dimat2000.cea.fr](http://www.dimat2000.cea.fr).

**24-28** 18th Intl. Liquid Crystal Conf., *Sendai, Japan*. T. Uchida, Executive Chair ILCC 2000, Dept. of Electronics, Graduate School of Engineering, Tohoku Univ., 05 Aza-aoba, Aramaki, Aoba-ku, Sendai 980-8579, Japan; 81-22-217-7117; fax 81-22-263-9404; e-mail ilcc2000@ecei.tohoku.ac.jp; <http://wwwsoc.nacsis.ac.jp/ilcs/ILCC2000>.

**30-4** SPIE Annual Meeting, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

## AUGUST 2000

**6-11** 7th International Symposium on Polymer Electrolytes (ISPE7), *Noosa, Queensland, Australia*. Astrid Nordmann, ISPE7 Conference Secretariat, Centre for Advanced Materials Technology, Monash University, Wellington Road, Clayton, Victoria, 3168, Australia; 61-3-9905-5791; fax 61-3-9904-4998; e-mail ispe7@eng.monash.edu.au; <http://www.chem.monash.edu.au/electrolytes/ispe7/>.

**6-11** 16th IUPAC Conf. on Chemical Thermodynamics, concurrent with 55th Calorimetry Conf. and 10th Symposium on Thermodynamics of Nuclear Materials, *Halifax, Nova Scotia, Canada*. M.A. White, Dept. of Chemistry, Dalhousie Univ., Halifax, Nova Scotia B3H 4J3, Canada; phone and fax 902-494-3894; e-mail icct@is.dal.ca; [http://is.dal.ca/\\_ICCT](http://is.dal.ca/_ICCT).

**6-11** Intl. Conf. on Magnetism, *Recife, Brazil*. S. Rezende; 55-81-281-8450; fax 55-81-271-0359; e-mail smr@df.ufpe.br.

**7-10** 8th Asia Pacific Physics Conf., *Taipei, Taiwan*. O. Huang, Conf. Secretariat, c/o Inst. of Physics, Academia Sinica, Nankang 115, Taipei, Taiwan; 886-2-27899602; fax 886-2-27829636; e-mail appc2k@phys.sinica.edu.tw.

**13-16** Nonlinear Optics Topical Meeting, *Maui, HI*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; <http://www.osa.org/mtg-conf>.

**15-19** Conf. on Nuclear Structure, *East Lansing, MI*. S. Conroy; 517-333-6333; e-mail NS2000@nslc.msu.edu; [www.nslc.msu.edu/conferences/NS2000](http://www.nslc.msu.edu/conferences/NS2000).

**16-20** 12th Intl. Conf. on Textures of Materials, *Montreal, Canada*. N. Procyshyn, Dept. of Mining and Metallurgical Engineering, McGill Univ., 3450 University St., Montreal, Quebec, H3A 2A7, Canada; 514-398-4383; fax 514-398-7099; e-mail norma@minmet.lan.mcgill.ca; <http://www.icotom12.ica.ca>.

**16-22** Jahn Teller Symposium, *Boston, MA*. M. Kaplan, Simmons College and Boston Univ.; 617-521-2727; e-mail kaplan@buphy.bu.edu.

**20-23** 39th Annual Conf. of Metallurgists, *Ottawa, Canada*. H. Mostaghaci, Advanced Materials Group, Industry Canada, 235 Queen St., Ottawa, ON K1A 0H5, Canada; 613-954-5012; fax 613-952-4209; e-mail mostaghaci.hamid@ic.gc.ca.

**20-25** 17th Intl. Conf. on Raman Spectroscopy, *Beijing, China*. H. Zhou, Secretary General, Dept. of Physics, Peking Univ., Beijing 100871, China; 8610-6275-1750; fax 8610-6275-9117; e-mail icors@pku.edu.cn; <http://www.hkics.com/icors2000> or <http://www.pku.edu.cn/others/icors/icors.htm>.

**22-26** *Ab initio* (from Electronic Structure) Calculations of Complex Processes in Materials, *Schwaebisch Gmuend, Germany*. e-mail psik-coord@daresbury.ac.uk.

**26-30** 15th European Conf. on Atomic and Molecular Physics of Ionized Gases, *Miskolc-Lillafured, Hungary*. Z. Donko, c/o Eotvos Lorand Physical Society, H-1371 Budapest, P.O. Box 433, Hungary; e-mail escampig@elft.mtesz.hu; <http://elft.mtesz.hu/escampig2000>.

**26-31** Scientific Basis for Nuclear Waste Management Symposium, *Sydney, Australia*. Conference Secretariat, PO Box Q894, QVB Post Office, Sydney NSW 1230 Australia; 61 2-9262-4211; fax 61 2-9262-4255; E-mail: facets@facetmanagement.com.au; <https://www.amlink.com.au/secure/ansto2000.htm>. **MRS.**

**27-30** Intl. Conf. on Spectroscopy of Ultra-Thin Films and Related Systems, *Xi'an, P.R. China*. Y. Fang, Spectroscopy Lab., Experimental Ctr., Capital Normal Univ., Beijing 100037, P.R. China; e-mail yfang@bnu.edu.cn; fax 8610-6841-6837.

## SEPTEMBER 2000

**3-8** Congress of Histochemistry and Cytochemistry, *York, UK*. Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-1865-248768; fax 44-1865-791237; e-mail meetings@rms.org.uk; <http://www.rms.org.uk>.

**4-9** 12th Intl. Conf. on Ion Beam Modification of Materials, *Porto Alegre, Brazil*. IBMM 2000, Inst. de Fisica, UFRGS, Campus do Vale, Caixa Postal 15051; 91501-970 Porto Alegre/RS, Brazil; 55-51-316-6323; fax 55-51-316-6510; e-mail IBMM2000@if.ufrgs.br.

**9-15** Intl. Symposium on the Process Metallurgy of Uranium, *Saskatoon, Canada*. C. Edwards, 306-956-6323; fax 306-956-6533; e-mail chuck\_edwards@cameco.com.

**10-14** ACerS Functionally Graded Materials Conf., *Estes Park, CO*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customerstrvc@acers.org; [www.acers.org](http://www.acers.org).

**10-15** Conf. on Lasers and Electro-Optics/Europe, and Intl. Quantum Electronics Conf., *Nice, France*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; <http://www.osa.org/mtg-conf>.

**13-15** 7th Intl. Conf. on Computer Methods in Composite Materials and Structures, *Bologna, Italy*. Conf. Secretariat CADCOMP 2000, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail wit@wessex.ac.uk; <http://www.wessex.ac.uk/conferences/2000>.

**13-15** Intl. Congress on Extractive Metallurgy and Mineral Processing, *Melbourne, Australia*. M.F. Marcin, Lev. 13, 15-31 Pelham St., Carlton, Victoria, Australia 3053; 61-3-4662-3166; fax 61-3-4662-3662.

**13-16** 2nd Intl. Conf. on Inorganic Materials, *Santa Barbara, CA*. S. Wilkinson, 2nd Intl. Conf. on Inorganic Materials, Elsevier Science Ltd., The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843691; fax 44-1865-843958; e-mail sm.wilkinson@elsevier.co.uk; [www.elsevier.com/locate/im2000](http://www.elsevier.com/locate/im2000).

**17-21** 9th Intl. Symposium on Superalloys, *Champion, PA*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; <http://www.tms.org>.

**17-22** 13th Intl. Conf. on Ion Implantation Technology, *Tyrol, Austria*. IIT 2000, c/o HS-B, Schottkystrasse 10, 91058 Erlangen, Germany; 49-9131-761-100; fax 49-9131-761-102; e-mail iit2000@is-b.fhg.de; <http://www.mfa.kfki.hu/IIT2000>.

**17-22** 25th Intl. Conf. on the Physics of Semiconductors, *Osaka, Japan*. C. Hamaguchi; 81-6-6879-7765; fax 81-6-6879-7753; e-mail hamaguti@ele.eng.osaka-u.ac.jp; <http://mc-net.jitbcm.com.jp/icps25>.

**17-22** 28th Photovoltaic Specialists Conf., *Anchorage, AK*. A. Rohatgi, Georgia Inst. of Technology, School of Electrical and Computer Engineering, 777 Atlantic Dr., Atlanta, GA 30332-0250; 404-894-7692; 404-894-5934; e-mail ajeet.rohatgi@ece.gatech.edu; <http://ieeepvsc@nrel.gov>.

**24-27** ACerS Manufacturing Workshop, *Louisville, KY*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customerstrvc@acers.org; [www.acers.org](http://www.acers.org).

**25-27** ▼ Intl. Conf. on Tungsten and Refractory Metals, *Annapolis, MD*. Metal Powder Industries Federation; 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail [info@mpif.org](mailto:info@mpif.org); [www.mpif.org](http://www.mpif.org).

## OCTOBER 2000

**1-4** Brimacombe Memorial Symposium, *Vancouver, Canada*. I. Samarasekera, Advanced Materials and Processing Engineering Lab., Univ. of British Columbia, Rm. 111-2355 East Mall, Vancouver, BC, Canada V6T 1Z4; 604-822-3668; fax 604-822-2965; e-mail [indira@cmpe.ubc.ca](mailto:indira@cmpe.ubc.ca).

**1-4** ACerS Glass and Optical Materials Division Fall Meeting, *Corning, NY*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail [customersrvc@acers.org](mailto:customersrvc@acers.org); [www.acers.org](http://www.acers.org).

**2-6** AVS 47th Intl. Symposium, *Boston, MA*. American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005-3993; 212-248-0200; fax 212-248-0245; e-mail [avsny@vacuum.org](mailto:avsny@vacuum.org); <http://www.vacuum.org>.

**4-7** ▼ Meeting of the APS Division of Nuclear Physics, *Williamsburg, VA*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; [www.aps.org](http://www.aps.org).

**8-11** ACerS Electronics Division Fall Meeting, *Clemson, SC*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail [customersrvc@acers.org](mailto:customersrvc@acers.org); [www.acers.org](http://www.acers.org).

**8-12** TMS Fall Meeting, *St. Louis, MO*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail [csc@tms.org](mailto:csc@tms.org); <http://www.tms.org>.

**11-13** 14th Intl. Conf. on Optical Fiber Sensors, *Venice, Italy*. A. Grazia Mignani, IRDE-CNR, Optics and Photonics Dept., Via Panciatichi 64, I-50127 Firenze, Italy; 39-55-4235-262; fax 39-55-4379-569; e-mail [mignani@iroe.fi.cnr.it](mailto:mignani@iroe.fi.cnr.it).

**14-16** ▼ 13th Intl. Symposium on Superconductivity, *Tokyo, Japan*. M. Yoshida, ISS 2000 Secretariat, ISTE, Shinbashi 5-34-3, Minato-ku, Tokyo 105-0004, Japan; fax 81-3-3431-4044; e-mail [joschida@istec.or.jp](mailto:joschida@istec.or.jp); [www.istec.or.jp](http://www.istec.or.jp).

**20-28** OSA Annual Meeting, *Providence, RI*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail [confserv@osa.org](mailto:confserv@osa.org); <http://www.osa.org/mtg-conf>.

**22-25** TMS Fall Extraction and Process Metallurgy Meeting, *Pittsburgh, PA*. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail [csc@tms.org](mailto:csc@tms.org); <http://www.tms.org/cms>.

**22-27** 198th Meeting of The Electrochemical Society, *Phoenix, AZ*. The Electrochemical Society, 10 S. Main St., Pennington, NJ 08534-2896; 609-737-1902; fax 609-737-2743; e-mail [ecs@electrochem.org](mailto:ecs@electrochem.org); <http://www.electrochem.org/meetings/>.

**23-27** ▼ Meeting of the APS Division of Plasma Physics, *Quebec, Canada*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; [www.aps.org](http://www.aps.org).

**30-2** 4th Intl. Conf. on High-Strength Low-Alloy Steels, *Xi'an, China*. HSLA Steels 2000 Secretariat, CSM, 46 Dongsixi Dajie, Beijing, China 100711; 86-10-6513-3925; fax 86-10-6512-4122; e-mail [csm@public.bta.net.cn](mailto:csm@public.bta.net.cn).

## NOVEMBER 2000

**1-4** ▼ 16th Intl. Conf. on the Application of Accelerators in Research and Industry, *Denton, TX*. J. Duggan; 940-565-3252; e-mail [stippecc@unt.edu](mailto:stippecc@unt.edu); [www.phys.unt.edu/accelcon/](http://www.phys.unt.edu/accelcon/).

**2-4** ▼ Meeting of the APS Southeastern Section, *Starkville, MS*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; [www.aps.org](http://www.aps.org).

**5-8** 2nd Intl. Conf. on Processing Materials for Properties, *San Francisco, CA*. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail [csc@tms.org](mailto:csc@tms.org); <http://www.tms.org/cms>.

**12-17** AIChE Annual Meeting, *Los Angeles, CA*. AIChE, 3 Park Ave., New York, NY 10016; <http://www.aiche.org>.

**13-14** ASTM Symposium on Marine Corrosion in Tropical Environments, *Merida, Yucatan, Mexico*. V. Chaker, Port Authority of NY-NJ, One World Trade Ctr., 74W, New York, NY 10048; 212-435-5790; fax 215-435-8040.

**19-21** ▼ Meeting of the APS Division of Fluid Dynamics, *Washington, DC*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; [www.aps.org](http://www.aps.org).

**19-23** ▼ 1st Intl. Conf. on Advanced Materials Processing, *Rotorua, New Zealand*. D. Zhang, Dept. of Mat. and Proc. Engineering, Univ. of Waikato, Private Bag 3105, Hamilton, New Zealand, fax 64-7-838-4835; e-mail [d.zhang@waikato.ac.nz](mailto:d.zhang@waikato.ac.nz).

**27-1** MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; <http://www.mrs.org/> MRS.

## DECEMBER 2000

**4-8** Intl. Conf. on Processing and Manufacturing of Advanced Materials, *Las Vegas, NV*. T. Chandra, Univ. of Wollongong, Dept. of Materials Engineering, Northfields Ave., Wollongong NSW 2522, Australia; 61-42-21-3008; fax 61-42-21-3112; e-mail [t.chandra@uow.edu.au](mailto:t.chandra@uow.edu.au).

## JANUARY 2001

**6-11** ▼ AAPT and AAS Joint Winter Meeting, *San Diego, CA*. AAPT Meetings Dept., One Physics Ellipse, College Park, MD 20740; e-mail [aapt-meet@aapt.org](mailto:aapt-meet@aapt.org); [www.aapt.org](http://www.aapt.org).

## FEBRUARY 2001

**5-7** IEEE Intl. Solid-State Circuits Conf., *San Francisco, CA*. D. Suiters, 202-331-2000; e-mail [isscc@courtesyassoc.com](mailto:isscc@courtesyassoc.com).

**5-9** Advanced Research Workshop on Semiconductor Nanostructures, *Blenheim, New Zealand*. D.J. Lockwood, Inst. for Microstructural Sciences, Natl. Research Council of Canada, 1191 Montreal Rd., Bldg. M-36, Ottawa, Ontario, Canada K1A 0R6; 613-993-9614; fax 613-993-6486; e-mail [david.lockwood@nrc.ca](mailto:david.lockwood@nrc.ca).

**11-15** TMS Annual Meeting, *New Orleans, LA*. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail [tmsgeneral@tms.org](mailto:tmsgeneral@tms.org); <http://www.tms.org/cms>.

## MARCH 2001

**12-16** ▼ APS March Meeting, *Seattle, WA*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; [www.aps.org](http://www.aps.org).

**25-30** 199th Meeting of the Electrochemical Society, *Washington, DC*. The Electrochemical Society, 10 S. Main St., Pennington, NJ 08534-2896; 609-737-1902; fax 609-737-2743; e-mail [ecs@electrochem.org](mailto:ecs@electrochem.org); <http://www.electrochem.org/meetings/>.

## APRIL 2001

**16-20** MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; <http://www.mrs.org> MRS.

**23-27** ▼ APS April Meeting, *Washington, DC*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; [www.aps.org](http://www.aps.org). □



## 2000 MRS Spring Meeting

April 24-28 SAN FRANCISCO, CA

### MEETING CHAIRS

Anna C. Balazs, University of Pittsburgh  
Robert Q. Hwang, Sandia National Laboratories  
Kevin S. Jones, University of Florida  
Frances M. Ross, IBM T.J. Watson Research Center

## 2000 MRS Fall Meeting

November 27 - December 1  
BOSTON, MASSACHUSETTS

### MEETING CHAIRS

Sungo Jin, Bell Labs  
Tony Mikos, Rice University  
David Srolovitz, University of Michigan  
Berndt Stritzker, University of Augsburg

## 2001 MRS Spring Meeting

April 16-24 SAN FRANCISCO, CA

### MEETING CHAIRS

Nicholas Cowern, Philips Research Laboratories  
Tomas Diaz de la Rubia, Lawrence Livermore National Laboratory  
Chad A. Mirkin, Northwestern University  
Cynthia Volkert, Max-Planck-Institut